



SPN68N15

N-Channel Enhancement Mode MOSFET

DESCRIPTION

The SPN68N15 is the N-Channel enhancement mode power field effect transistors are produced using high cell density, DMOS trench technology. The SPN68N15 has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low $R_{DS(ON)}$ and fast switching speed.

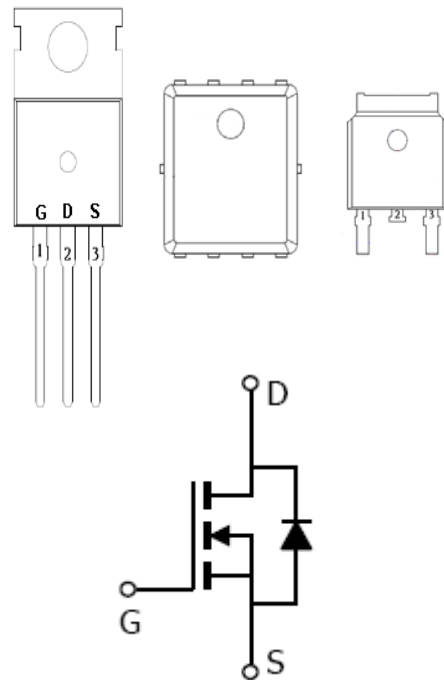
FEATURES

- ◆ 150V/68A, $R_{DS(ON)}=17\text{ m}\Omega@V_{GS}=10\text{V}$
- ◆ Super high density cell design for extremely low $R_{DS(ON)}$
- ◆ Exceptional on-resistance and maximum DC current capability

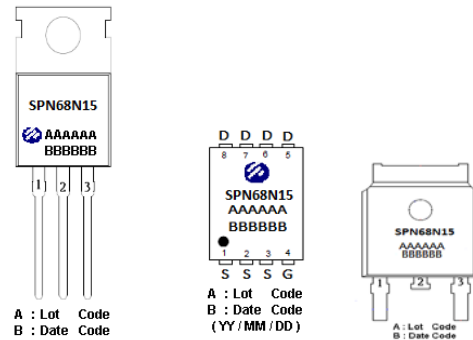
APPLICATIONS

- DC/DC Converter
- Load Switch
- SMPS Secondary Side Synchronous Rectifier
- Motor Control
- Power Tool

PIN CONFIGURATION



PART MARKING





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PIN DESCRIPTION

TO-220/TO-252

Pin	Symbol	Description
1	G	Gate
2	D	Drain
3	S	Source

PPAK5x6

Pin	Symbol	Description
4	G	Gate
5-8	D	Drain
1-3	S	Source

ORDERING INFORMATION

Part Number	Package	Part Marking
SPN68N15T220TGB	TO-220-3L	SPN68N15
SPN68N15DN8RGB	PPAK5X6	SPN68N15

※ SPN68N15T220TGB : Tube ; Pb – Free ; Halogen – Free

※ SPN68N15T252RGB: T/R ; Pb – Free ; Halogen – Free

※ SPN68N15DN8RGB : T/R ; Pb – Free ; Halogen – Free

ABSOLUTE MAXIMUM RATINGS

(TA=25°C Unless otherwise noted)

Parameter	Symbol	Typical	Unit
Drain-Source Voltage	V _{DSS}	150	V
Gate –Source Voltage	V _{GSS}	±20	V
Continuous Drain Current (Silicon Limited)	I _D	T _C =25°C	68
		T _C =100°C	48
Pulsed Drain Current	I _{DM}	230	A
Single Pulse Avalanche Energy (T _C =25°C, L=0.4mH.)	E _{AS}	125	mJ
Power Dissipation@ T _C =25°C	P _D	TO-220/TO-252	175
		PPAK5x6	95
Operating Junction Temperature	T _J	-55/150	°C
Storage Temperature Range	T _{STG}	-55/150	°C
Thermal Resistance-Junction to Case	R _{θJC}	TO-220/TO-252	0.86
		PPAK5x6	1.3



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ELECTRICAL CHARACTERISTICS

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Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
Static						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=250\mu A$	150			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	2.0		4.0	
Gate Leakage Current	I_{GSS}	$V_{DS}=0V, V_{GS}=\pm 20V$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=120V, V_{GS}=0V$ $T_J=25^\circ C$,			1	uA
		$V_{DS}=120V, V_{GS}=0V$, $T_J=100^\circ C$			100	
Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=20A$			17	mΩ
Forward Transconductance	g_{fs}	$V_{DS}=5V, I_D=20A$		58		S
Gate resistance	R_g	$V_{DS}=0V, V_{GS}=0V$ $f=1MHz$		1.5		Ω
Diode Forward Voltage	V_{SD}	$I_S=20A, V_{GS}=0V$		0.9	1.2	V
Dynamic						
Total Gate Charge	Q_g	$V_{DS}=75V, V_{GS}=10V$ $I_D=20A$		30		nC
Gate-Source Charge	Q_{gs}			9		
Gate-Drain Charge	Q_{gd}			4		
Input Capacitance	C_{iss}	$V_{DS}=75V, V_{GS}=0V$ $f=1MHz$		2500		pF
Output Capacitance	C_{oss}			185		
Reverse Transfer Capacitance	C_{rss}			10.5		
Turn-On Time	$t_{d(on)}$	$V_{DD}=75V$, $I_D=20A, V_{GS}=10V$ $R_G=10\Omega$		12		nS
	t_r			8		
Turn-Off Time	$t_{d(off)}$			25		
	t_f			9		



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TYPICAL CHARACTERISTICS

Fig 1. Typical Output Characteristics

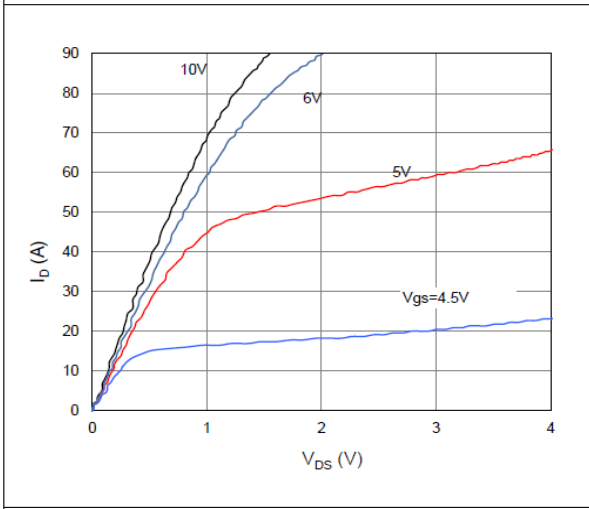


Figure 2. On-Resistance vs. Gate-Source Voltage

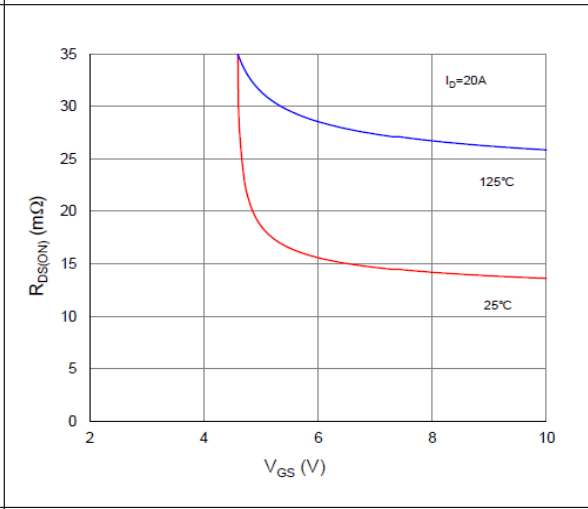


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

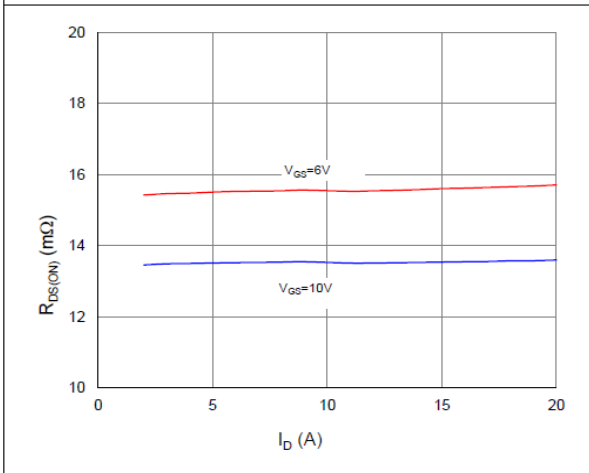


Figure 4. Normalized On-Resistance vs. Junction Temperature

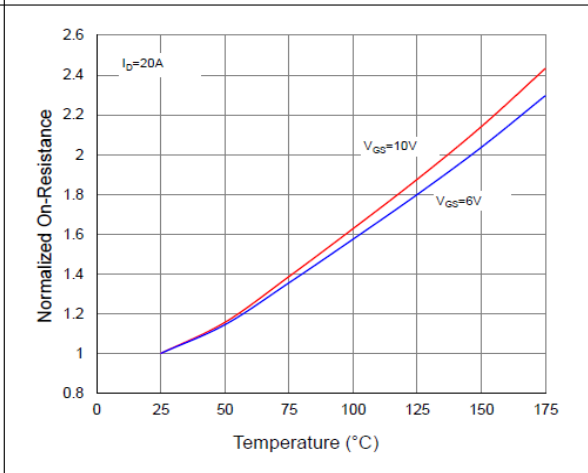


Figure 5. Typical Transfer Characteristics

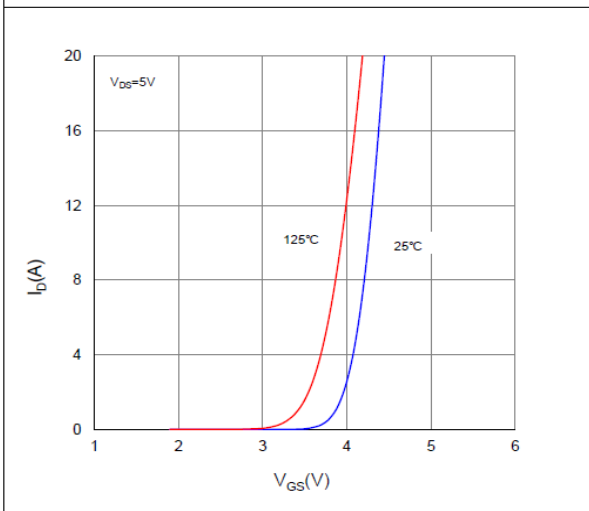
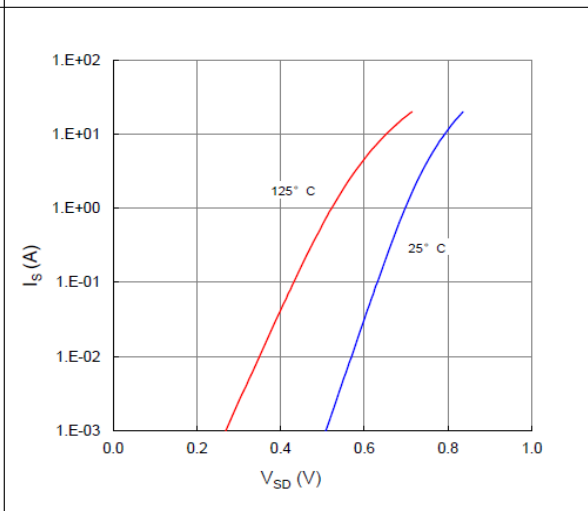


Figure 6. Typical Source-Drain Diode Forward Voltage





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TYPICAL CHARACTERISTICS

Figure 7. Typical Gate-Charge vs. Gate-to-Source Voltage

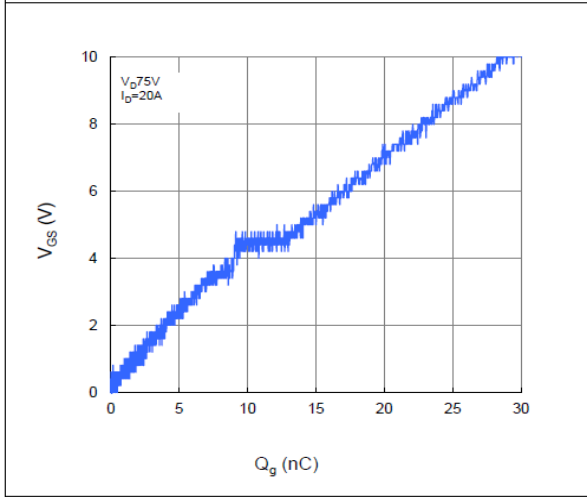


Figure 8. Typical Capacitance vs. Drain-to-Source Voltage

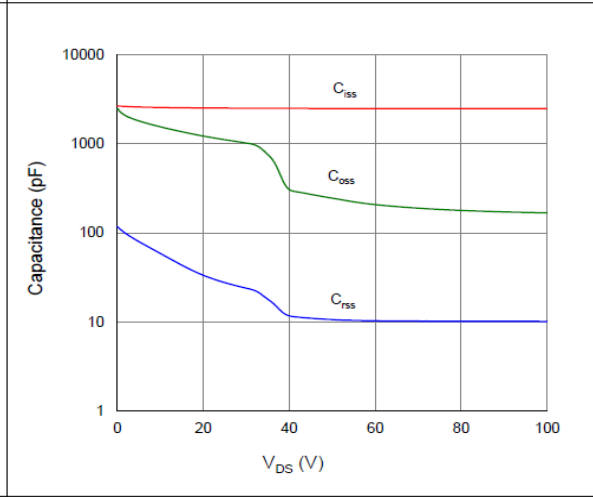


Figure 9. Maximum Safe Operating Area

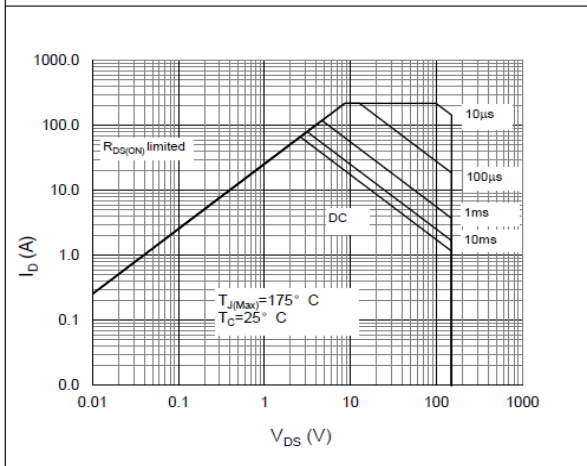


Figure 10. Maximum Drain Current vs. Case Temperature

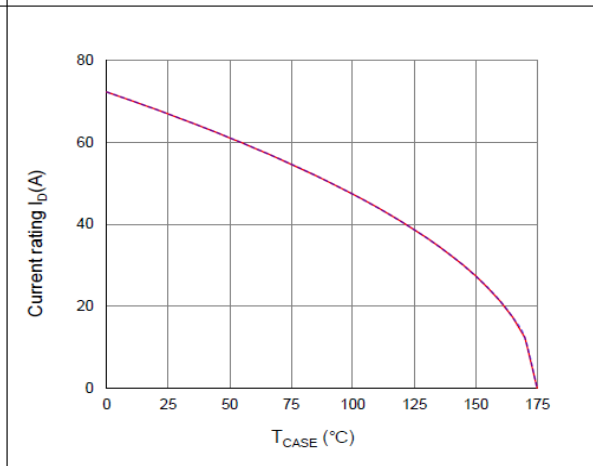
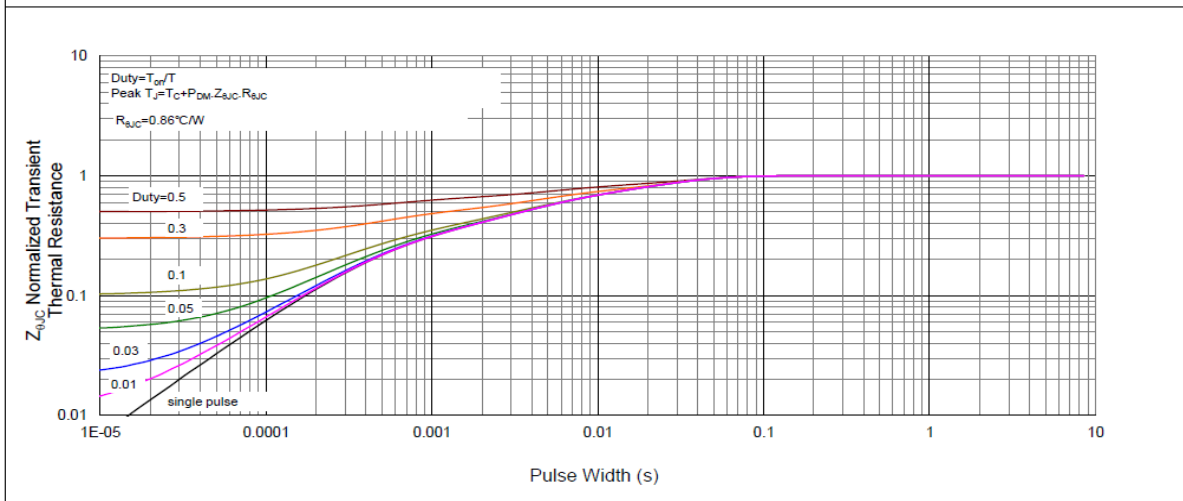


Figure 11. Normalized Maximum Transient Thermal Impedance, Junction-to-Case





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